Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265 Additional name(s) & address(es) attached?Yes _X_No 3. Nature of Conveyance:X_ Assignment Merger Security Agreement Change of Name Other Execution Date in order of listed parties: 9/16/03 4. Application number(s) or patent number(s), _This document is being filed together with a new application. Execution date of the application in order of listed parties: 9/16/03 Title: Package for a Semiconductor Device Docket No: TI-35494 A Patent Application No.(s) S.N. 10/651,522 Additional numbers attached?Yes _X_No 5. Name and address of party to whom correspondence concerning 6. Number of applications and patents involved:(1)	TI-35484	100620020	Patent and Trade
1. Name of conveying party(les): Name: TEXAS INSTRUMENTS INCORPORATED		original documents or copy thereof.	
Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265 Additional name(s) & address(es) attached?Yes _X_No 3. Nature of Conveyance:X_Assignment Merger Security Agreement Change of Name Other Execution Date in order of listed parties: 9/16/03 4. Application number(s) or patent number(s). This document is being filed together with a new application. Execution date of the application in order of listed parties: 9/16/03 Title: Package for a Semiconductor Device Docket No: Ti-35484 A Patent Application No.(s) S.N. 10/651.522	1. Name of conveying party(ies): 3 TEACLY	2. Name and Address of receiving party	v(ies):
City: Dallas State: TX Zip: 75265 Additional name(s) & address(es) attached?Yes _X_No 3. Nature of Conveyance:X_AssignmentMergerSecurity AgreementChange of NameOtherExecution Date in order of listed parties: 9/16/03 4. Application number(s) or patent number(s). This document is being filled together with a new application. Execution date of the application in order of listed parties: 9/16/03 Title: Package for a Semiconductor Device Docket No: TI-35484 A Patent Application No.(s) S.N. 10/651.522	Kenji Masumoto 9/16/03	Name: TEXAS INSTRUMENTS IN	CORPORATED
State: TX Zip: 75265 Additional name(s) & address(es) attached?Yes _X_No 3. Nature of Conveyance:X_AssignmentMergerSecurity AgreementChange of NameOther Execution Date in order of listed parties: 9/16/03 4. Application number(s) or patent number(s), _This document is being filed together with a new application. Execution date of the application in order of listed parties: 9/16/03 Title: Package for a Semiconductor Device Docket No. Th-35484 A. Patent Application No.(s) _S.N. 10/651.622	12/19/0	Address: P.O. Box 655474, MS 3999	•
Additional name(s) & address(es) attached?Yes _X_No 3. Nature of Conveyance:X_ Assignment Merger Security Agreement Change of Name Other Execution Date in order of listed parties: 9/16/03 4. Application number(s) or patent number(s). This document is being filed together with a new application. Execution date of the application in order of listed parties: 9/16/03 Title: Package for a Semiconductor Device Docket No: TI-35484 A Patent Application No.(s) S.N. 10/651.522 Additional numbers attached? Yes _X_No 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Michael K. Skrehot		City: Dallas	
3. Nature of Conveyance: X_Assignment		State: TX	Zip: 75265
		Additional name(s) & address(es) attache	ed? Yes _X_ No
Security AgreementChange of NameOther Execution Date in order of listed parties: 9/16/03 4. Application number(s) or patent number(s). This document is being filed together with a new application. Execution date of the application in order of listed parties: 9/16/03 Title: Package for a Semiconductor Device Docket No: TI-35484 A. Patent Application No.(s) S.N. 10/651,522	3. Nature of Conveyance:		
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	Execution Date in order of listed parties: 9/16/03		
Title: Package for a Semiconductor Device Docket No: TI-35484 A. Patent Application No.(s) S.N. 10/651,522 Additional numbers attached?YesXNo 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Michael K. Skrehot Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265 7. Amount of fee enclosed or authorized to be charged: \$40 8. Deposit Account No: 20-0668 (Attach duplicate copy if paying by deposit account)	Application number(s) or patent number(s). _This document is being filed together with a new application.		
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Deposit Account No: 20-0668 (Attach duplicate copy if paying by deposit account)	State: TX Zip: 75265		
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2/ 8 01 121	Date	Michael K. Skre	hot, Reg. No. 36,682
12-9-03 Ulffelt	/ Total Number of Pages Including Co	over Sheet, Attachments and Document:2	

PATENT REEL: 014802 FRAME: 0658

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Package for a Semiconductor Device		
SIGNATURE OF INVENTOR AND NAME	Kenji Masumoto	N/A	N/A
DATE OF SIGNATURE	× 9/16 03		
RESIDENCE (City, State)	Oita, Japan		
DATE APPLICATION EXECUTED			

After recording Assignment, please return to:

Michael K. Skrehot
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265

PATENT RECORDED: 12/12/2003 REEL: 014802 FRAME: 0659